

**Notice of References Cited**

Application/Control No.

09/431,477

Applicant(s)/Patent Under

Reexamination

GANESH ET AL.

Examiner

Phallaka Kik

Art Unit

2825

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*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
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	C	US-			
	D	US-			
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	K	US-			
	L	US-			
	M	US-			

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\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)  
 Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.